

09/982,221

Amend claims 19 and 22 as follows:

1 19. (Twice Amended) A multi-layer substrate structure comprising:

B₁₂
2 at least one layer having generic electrical features altered to customize said
3 layer,
4 wherein said electrical features include vias,
5 wherein said vias are selectively filled with a conducting material and an
6 insulating material.

B₂
1 22. (Twice Amended) The multi-layer substrate structure in claim 19, further
2 comprising a second layer similar to said layer and having said generic electrical
3 features including vias altered differently than said layer to customize said
4 second layer differently than said layer, wherein said vias in said second layer
5 are selectively filled with a conducting material and an insulating material.

Add new claims 29 and 30 as follows:

FIS919980205US2

-2-